



20V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _A = +25°C
20V	$100 m\Omega @ V_{GS} = 4.5V$	1.8A
200	140mΩ @ $V_{GS} = 2.5V$	1.5A

Description

This new generation MOSFET is designed to minimize the on-state resistance ($R_{DS(ON)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

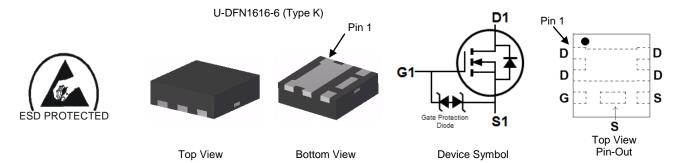
- Power Management Functions
- Load Switch

Features and Benefits

- Typical Off Board Profile of 0.6mm Ideally Suited for Thin Applications
- Low R_{DS(ON)} Minimizes Conduction Losses
- PCB Footprint of 2.56mm²
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: U-DFN1616-6
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Lead Free Plating (NiPdAu Finish over Copper Leadframe). (e4)
- Terminals: Solderable per MIL-STD-202, Method 208
- Weight: 0.003 grams (Approximate)



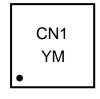
Ordering Information (Note 4)

- 3			
	Part Number	Case	Packaging
	DMN2120UFCL-7	U-DFN1616-6 (Type K)	3,000/Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



CN1 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: G = 2019) M = Month (ex: 9 = September)

Date Code Key

Year	2019	2	020	2021		2022	2023		2024	2025		2026
Code	G		Н	1		J	K		L	М		Ν
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings $(@T_A = +25^{\circ}C, \text{ unless otherwise specified.})$

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage	V _{DSS}	20	V		
Gate-Source Voltage	V _{GSS}	±12	V		
Continuous Drain Current (Note 6) $V_{GS} = 4.5V$ Steady $T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$				1.8 1.4	А
Pulsed Drain Current (380µs Pulse, 1% Duty Cy	cle) (Note 7	I _{DM}	10	Α	
Maximum Continuous Body Diode Forward Curre	ent (Note 6)	Is	0.7	Α	

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P _D	0.45	W
Thermal Resistance, Junction to Ambient @T _A = +25°C (Note 5)	$R_{ heta JA}$	270	°C/W
Power Dissipation (Note 6)	P _D	1.16	W
Thermal Resistance, Junction to Ambient @T _A = +25°C (Note 6)	$R_{ heta JA}$	108	°C/W
Operating and Storage Temperature Range	T _{J,} T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV _{DSS}	20	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	_	_	1.0	μΑ	V _{DS} = 16V, V _{GS} = 0V	
Gate-Source Leakage	I _{GSS}		_	±10	μΑ	$V_{GS} = \pm 12V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)			•		•		
Gate Threshold Voltage	V _{GS(TH)}	0.3	_	1.0	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
		_	57	100		$V_{GS} = 4.5V, I_D = 3.6A$	
Static Drain-Source On-Resistance	R _{DS(ON)}		69	140	mΩ	V _{GS} = 2.5V, I _D = 3.1A	
		_	74	200		V _{GS} = 1.8V, I _D = 1A	
Diode Forward Voltage	V _{SD}		0.7	1.2	V	V _{GS} = 0V, I _S = 1.6A	
DYNAMIC CHARACTERISTICS (Note 9)			•		•		
Input Capacitance	C _{iss}	_	130	_	pF		
Output Capacitance	Coss	_	26	_	pF	$V_{DS} = 10V, V_{GS} = 0V,$ -f = 1.0MHz	
Reverse Transfer Capacitance	C _{rss}		18	_	pF	1 = 1.0WII 12	
Gate Resistance	Rg	_	2.7	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	1.4	_	nC		
Total Gate Charge (V _{GS} = 10V)	Qg	_	2.8	_	nC	10/ 10/ 1	
Gate-Source Charge	Q _{gs}	_	0.1	_	nC	$V_{DS} = 10V, I_{D} = 3.6A$	
Gate-Drain Charge	Q_{gd}	_	0.5	_	nC		
Turn-On Delay Time	t _{D(ON)}	_	0.6	_	ns		
Turn-On Rise Time	t _R		2.7	_	ns	$V_{DD} = 10V, V_{GS} = 4.5V,$	
Turn-Off Delay Time	t _{D(OFF)}		4.2	_	ns	$I_D = 1A$, $R_G = 6\Omega$, $R_L = 10\Omega$	
Turn-Off Fall Time	t _F		1.7	_	ns		
Body Diode Reverse Recovery Time	t _{RR}		10	_	ns	I _F = 4A, dI/dt = 100A/µs	
Body Diode Reverse Recovery Charge	Q _{RR}	_	1.0	_	nC	- 4Λ, αι/αι	

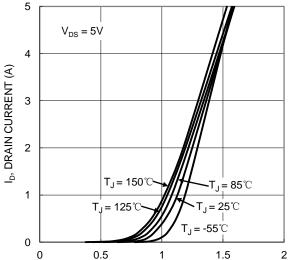
Notes:

- 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

 7. Repetitive rating, pulse width limited by junction temperature.
- 8. Short duration pulse test used to minimize self-heating effect.
- 9. Guaranteed by design. Not subject to product testing.

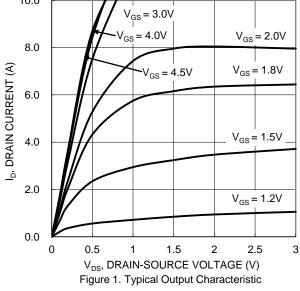


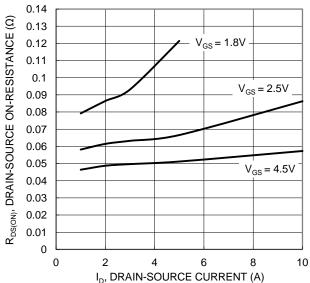
10.0 V_{GS} = 3.0V

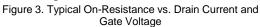


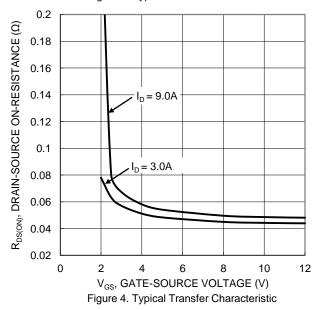
DMN2120UFCL

V_{GS}, GATE-SOURCE VOLTAGE (V) Figure 2. Typical Transfer Characteristic









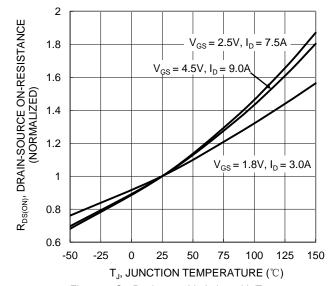


Figure 6. On-Resistance Variation with Temperature

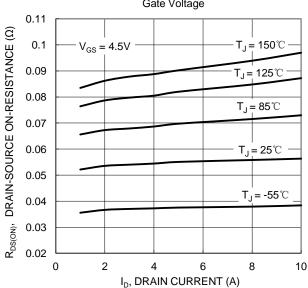


Figure 5. Typical On-Resistance vs. Drain Current and Temperature





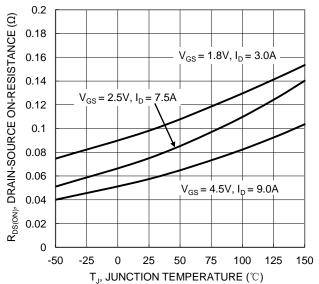


Figure 7. On-Resistance Variation with Temperature

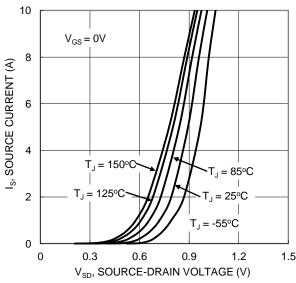
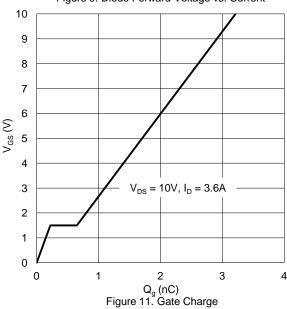


Figure 9. Diode Forward Voltage vs. Current



1 $V_{GS(TH)}$, GATE THRESHOLD VOLTAGE (V) 0.9 8.0 $I_D = 1mA$ 0.7 0.6 0.5 $I_{D} = 250 \mu A$ 0.4 0.3 0.2 -50 -25 0 25 50 75 100 125 150 T_J, JUNCTION TEMPERATURE (°C)

Figure 8. Gate Threshold Variation vs. Junction Temperature

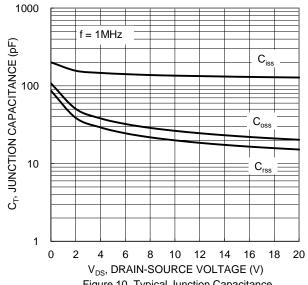
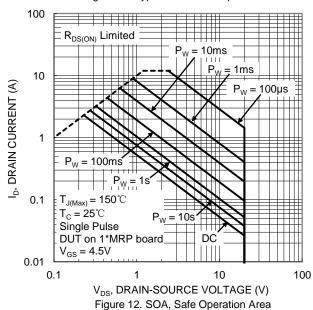


Figure 10. Typical Junction Capacitance





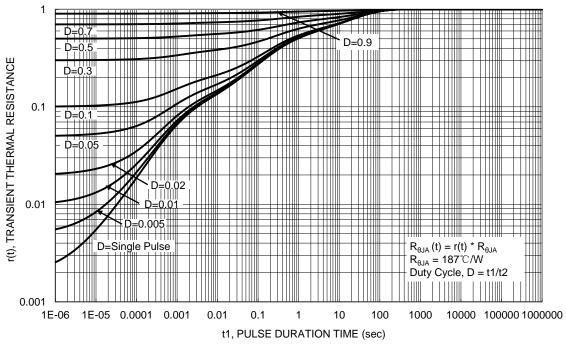


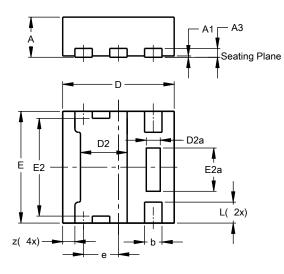
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN1616-6 (Type K)

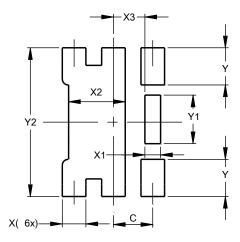


U-DFN1616-6 (Type K)							
Dim	Min	Max	Тур				
Α	0.55	0.60	0.575				
A1	0.00	0.05	0.02				
A3			0.13				
b	0.20	0.30	0.25				
D	1.55	1.65	1.60				
D2	0.57	0.77	0.67				
D2a	0.10	0.30	0.20				
е	-		0.50				
Е	1.55	1.65	1.60				
E2	1.30	1.50	1.40				
E2a	0.52	0.72	0.62				
L	0.25	0.35	0.30				
z	1		0.175				
All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN1616-6 (Type K)



Dimensions	Value (in mm)
	` '
C	0.500
X	0.300
X1	0.200
X2	0.720
Х3	0.400
Υ	0.475
Y1	0.620
Y2	1.900



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